



US00D490793S

(12) **United States Design Patent**
Tsai et al.

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(45) **Date of Patent:** **** Jun. 1, 2004**

(54) **MOBILE PHONE**

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(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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Aug. 20, 2003	(TW)	92305029 U03
Aug. 20, 2003	(TW)	92305029 U01

(51) **LOC (7) Cl.** **14-03**

(52) **U.S. Cl.** **D14/138**

(58) **Field of Search** D14/137, 138,
D14/218, 147-148, 247-248, 144, 341-347;
379/433.01-433.13, 419, 434, 428.01-428.04,
420.01-420.04, 440; 455/550.1-90.3; D21/517;
D13/168; D18/2, 7; 345/168, 169

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(List continued on next page.)

Primary Examiner—Jeffrey Asch

(74) *Attorney, Agent, or Firm*—Quintero Law Office

(57) **CLAIM**

The ornamental design for a mobile phone, as shown and described.

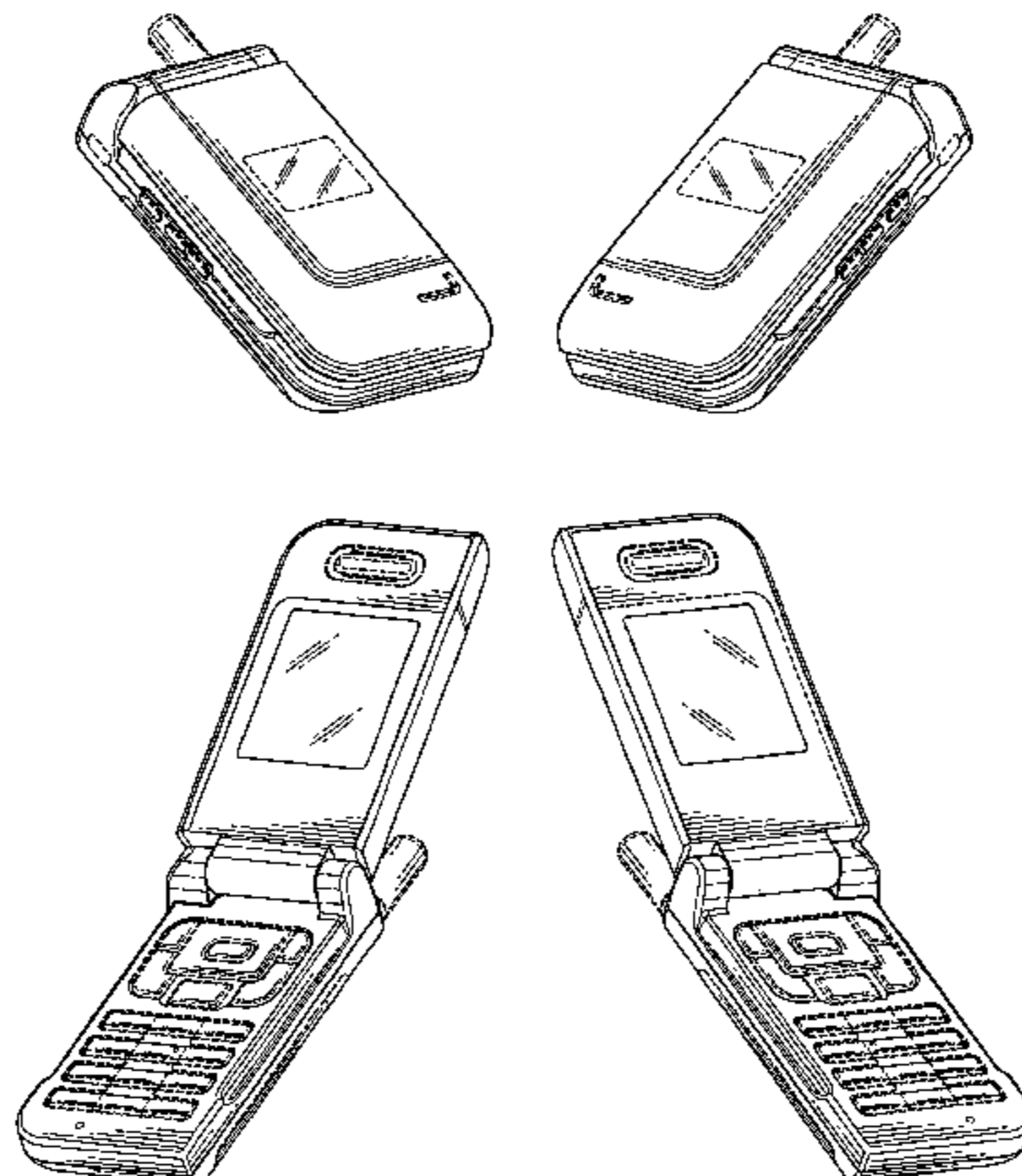
DESCRIPTION

FIG. 1 is a perspective view of the first embodiment;
FIG. 2 is a front elevational view of the first embodiment;
FIG. 3 is a rear elevational view of the first embodiment;
FIG. 4 is a left side elevational view of the first embodiment;
FIG. 5 is a right side elevational view of the first embodi-
ment;

FIG. 6 is a top plane view of the first embodiment;
FIG. 7 is a bottom plane view of the first embodiment;
FIG. 8 is a perspective view in use state of the first
embodiment;
FIG. 9 is a perspective view of the second embodiment;
FIG. 10 is a front elevational view of the second embodi-
ment;
FIG. 11 is a rear elevational view of the second embodiment;
FIG. 12 is a left side elevational view of the second
embodiment;
FIG. 13 is a right side elevational view of the second
embodiment;
FIG. 14 is a top plane view of the second embodiment;
FIG. 15 is a bottom plane view of the second embodiment;
FIG. 16 is a perspective view in use state of the second
embodiment;
FIG. 17 is a perspective view of the third embodiment;
FIG. 18 is a front elevational view of the third embodiment;
FIG. 19 is a rear elevational view of the third embodiment;
FIG. 20 is a left side elevational view of the third embodi-
ment;
FIG. 21 is a right side elevational view of the third embodi-
ment;
FIG. 22 is a top plane view of the third embodiment;
FIG. 23 is a bottom plane view of the third embodiment;
FIG. 24 is a perspective view in use state of the third
embodiment;
FIG. 25 is a perspective view of the fourth embodiment;
FIG. 26 is a front elevational view of the fourth embodi-
ment;
FIG. 27 is a rear elevational view of the fourth embodiment;
FIG. 28 is a left side elevational view of the fourth embodi-
ment;
FIG. 29 is a right side elevational view of the fourth
embodiment;
FIG. 30 is a top plane view of the fourth embodiment;
FIG. 31 is a bottom plane view of the fourth embodi-
ment;
and,
FIG. 32 is a perspective view in use state of the fourth
embodiment.

The broken line showings throughout the views are for illustrative purposes only and form no part of the claimed design.

1 Claim, 20 Drawing Sheets



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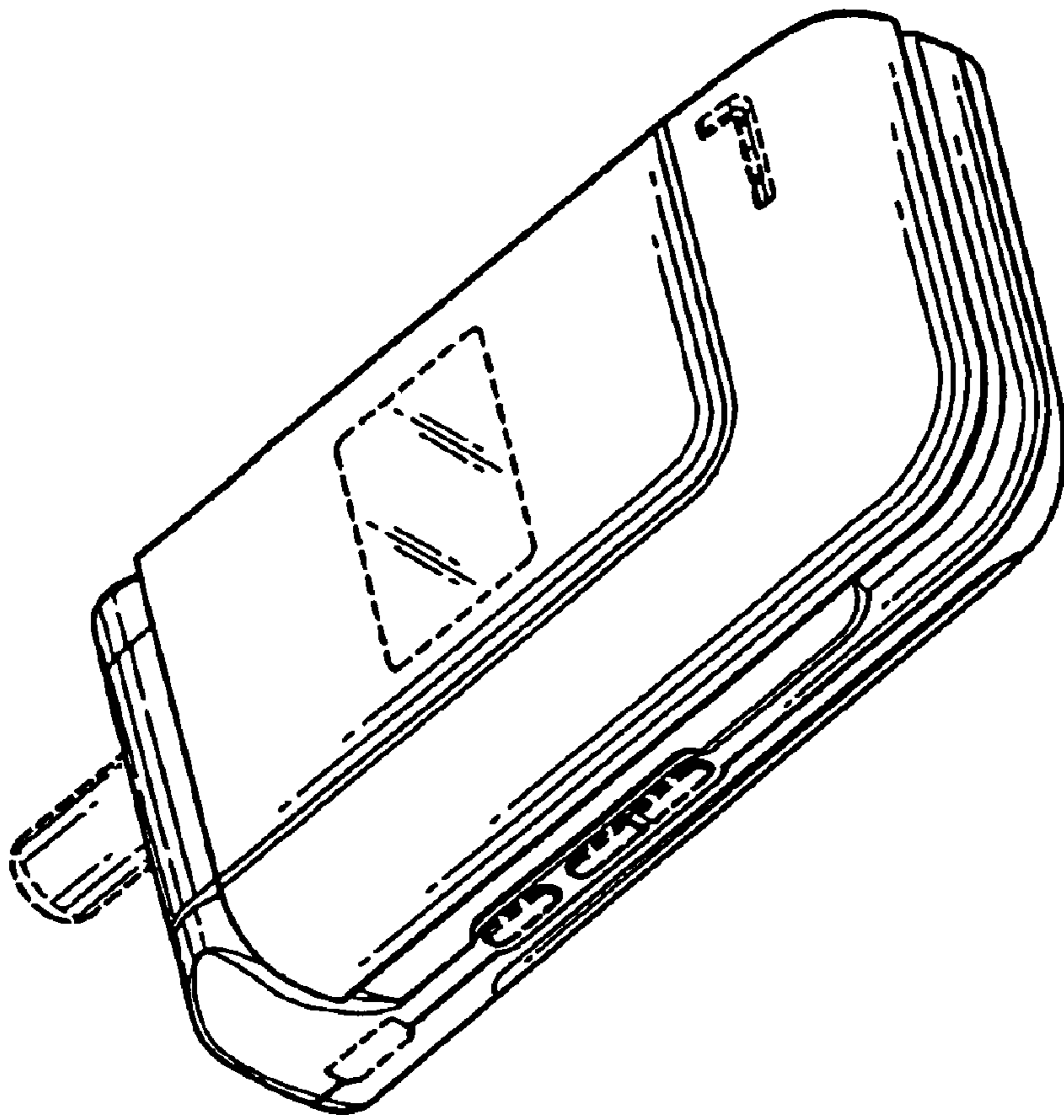


FIG. 1

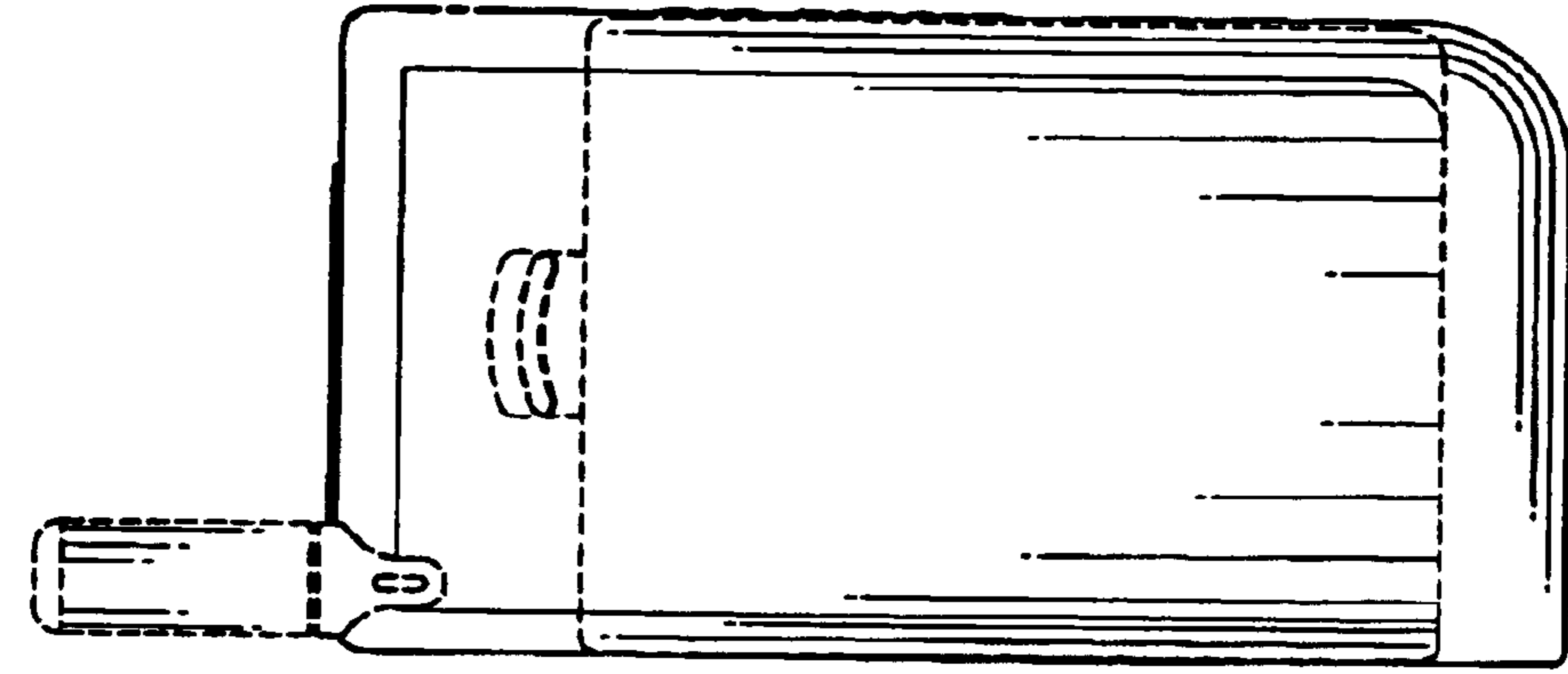


FIG. 3

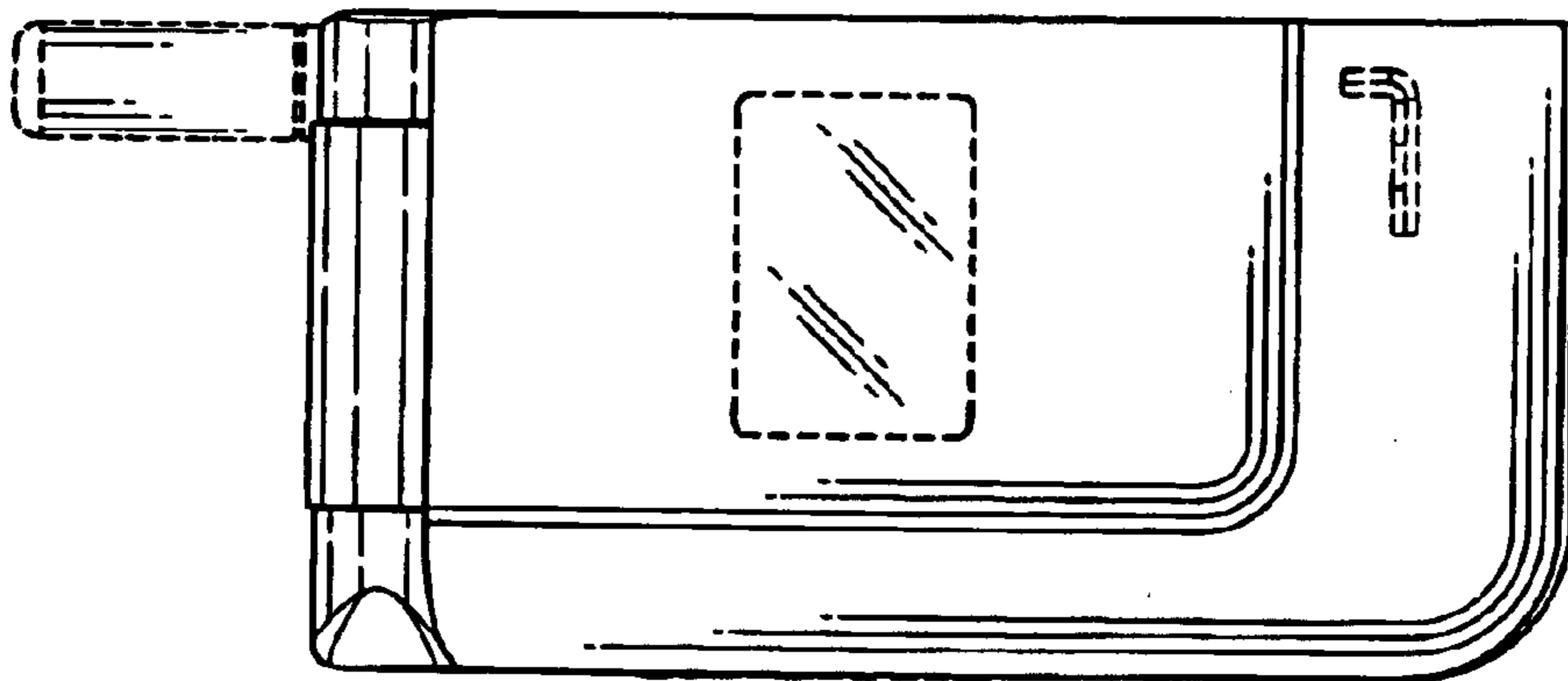


FIG. 2

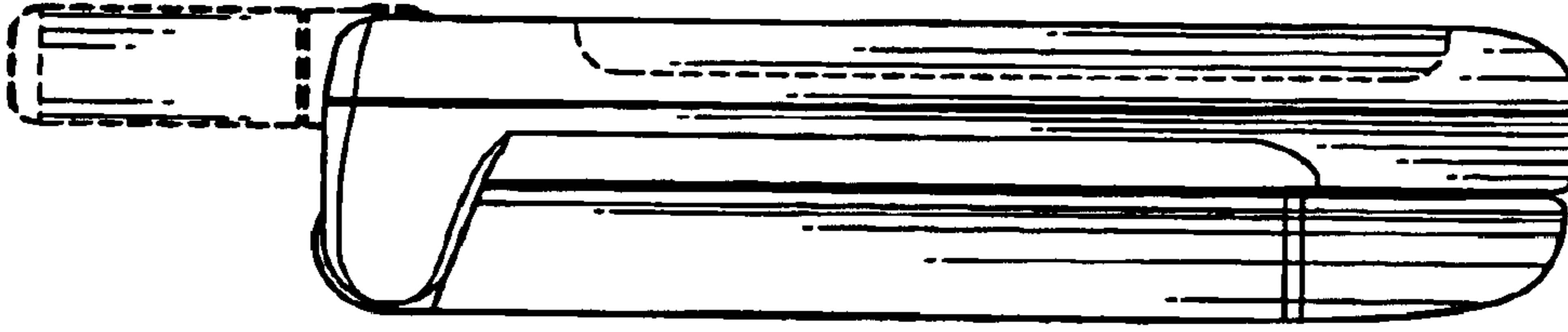


FIG. 5

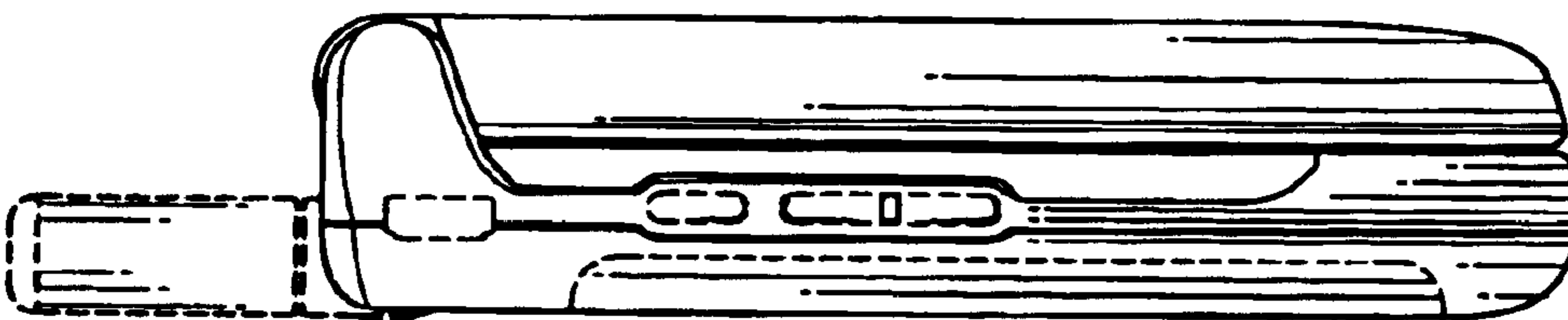


FIG. 4

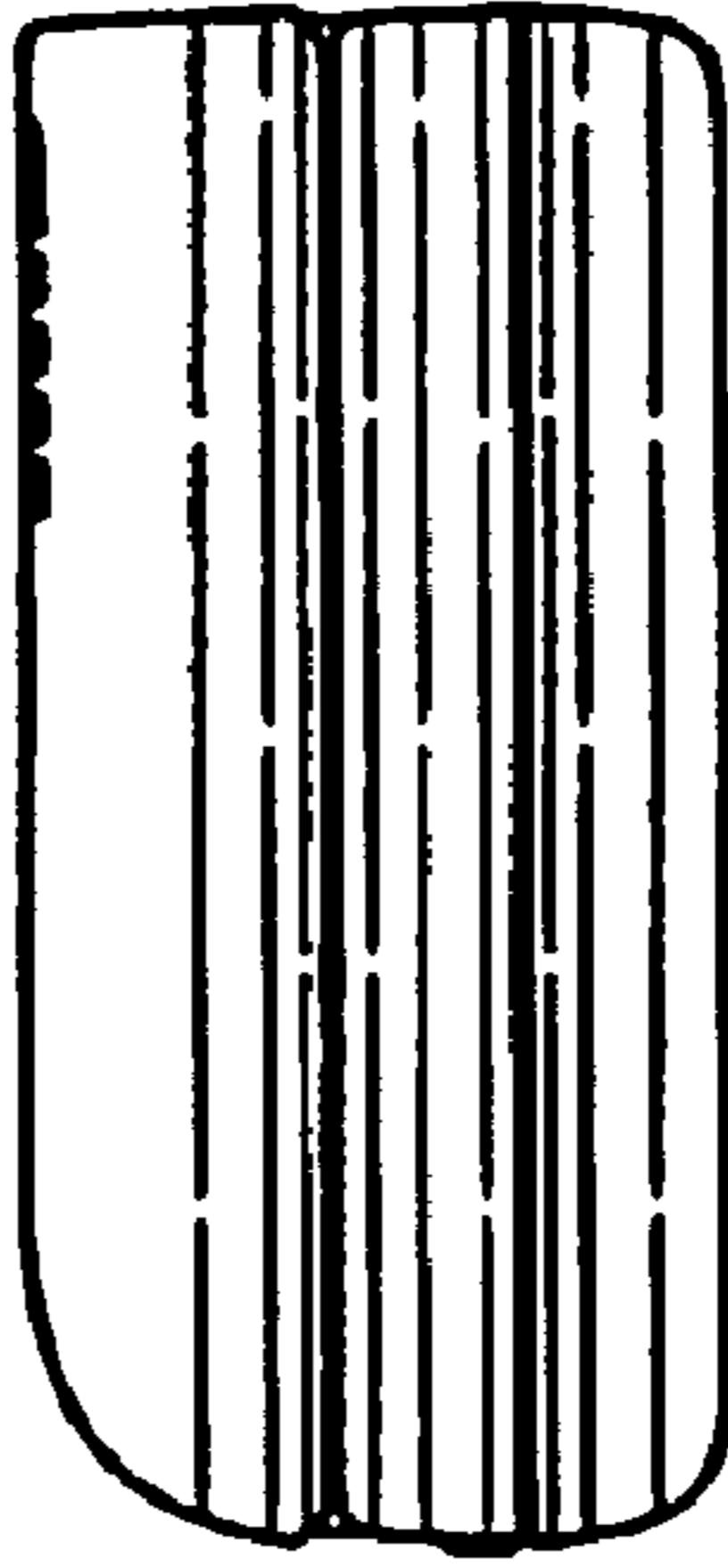


FIG. 7

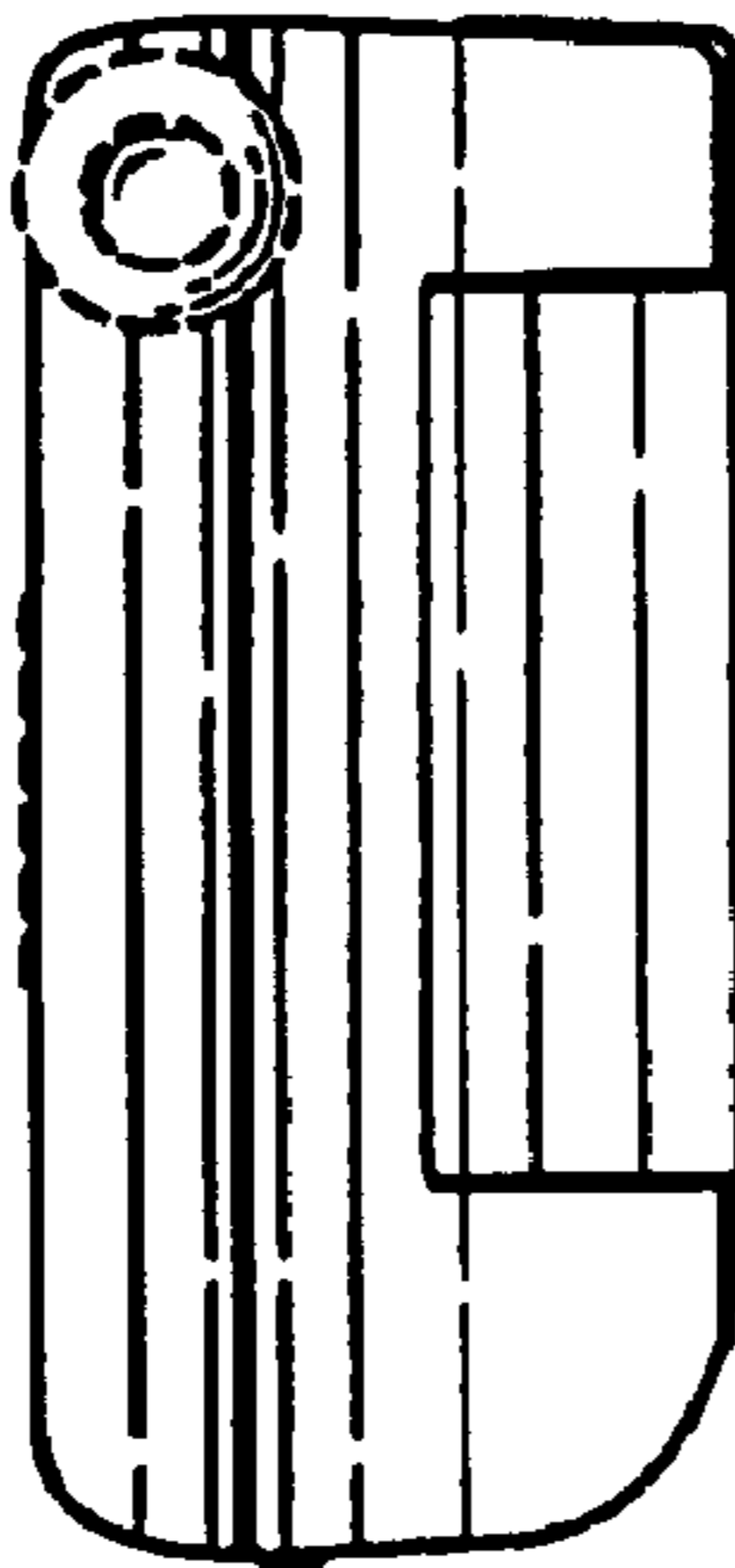


FIG. 6

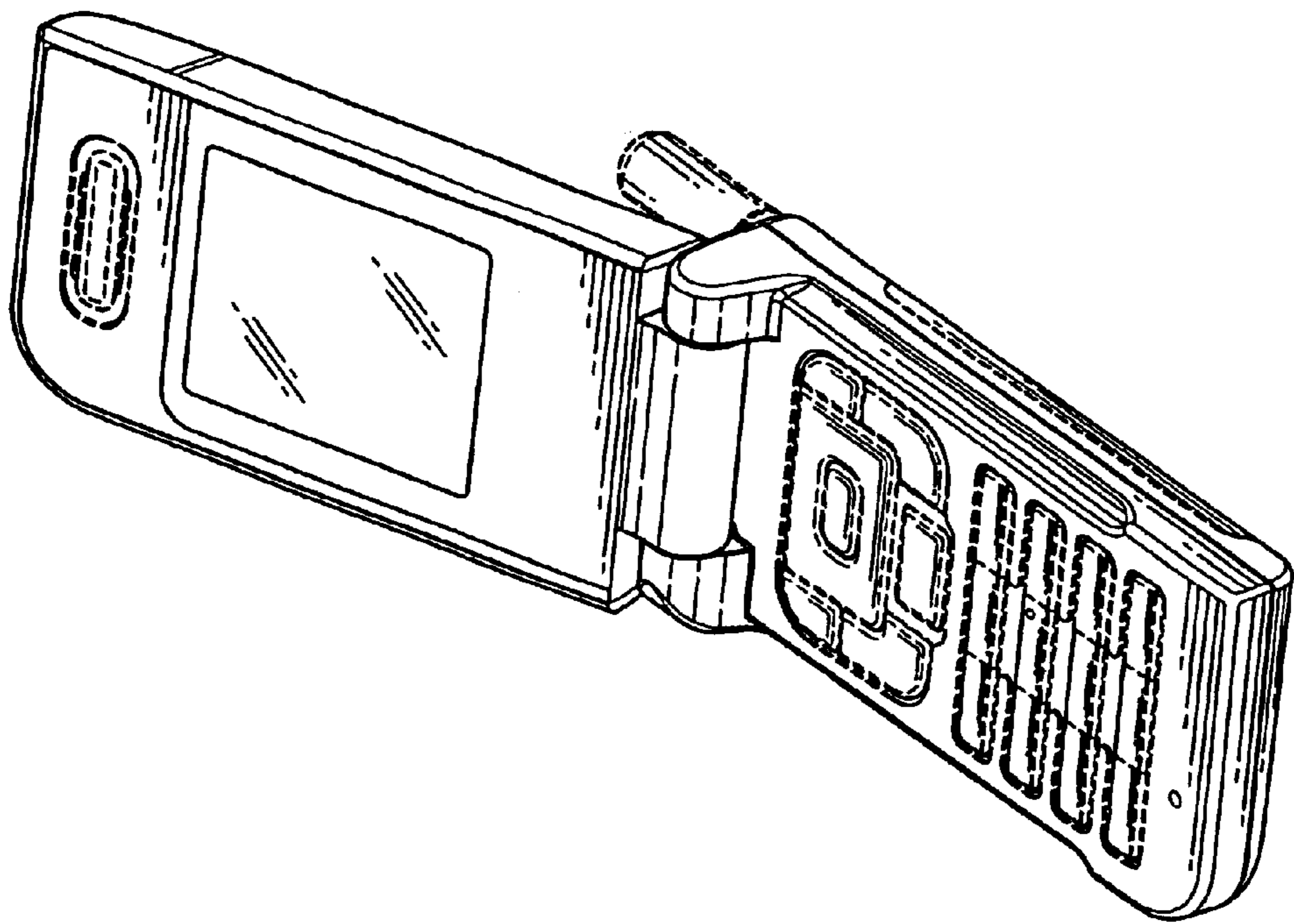


FIG. 8

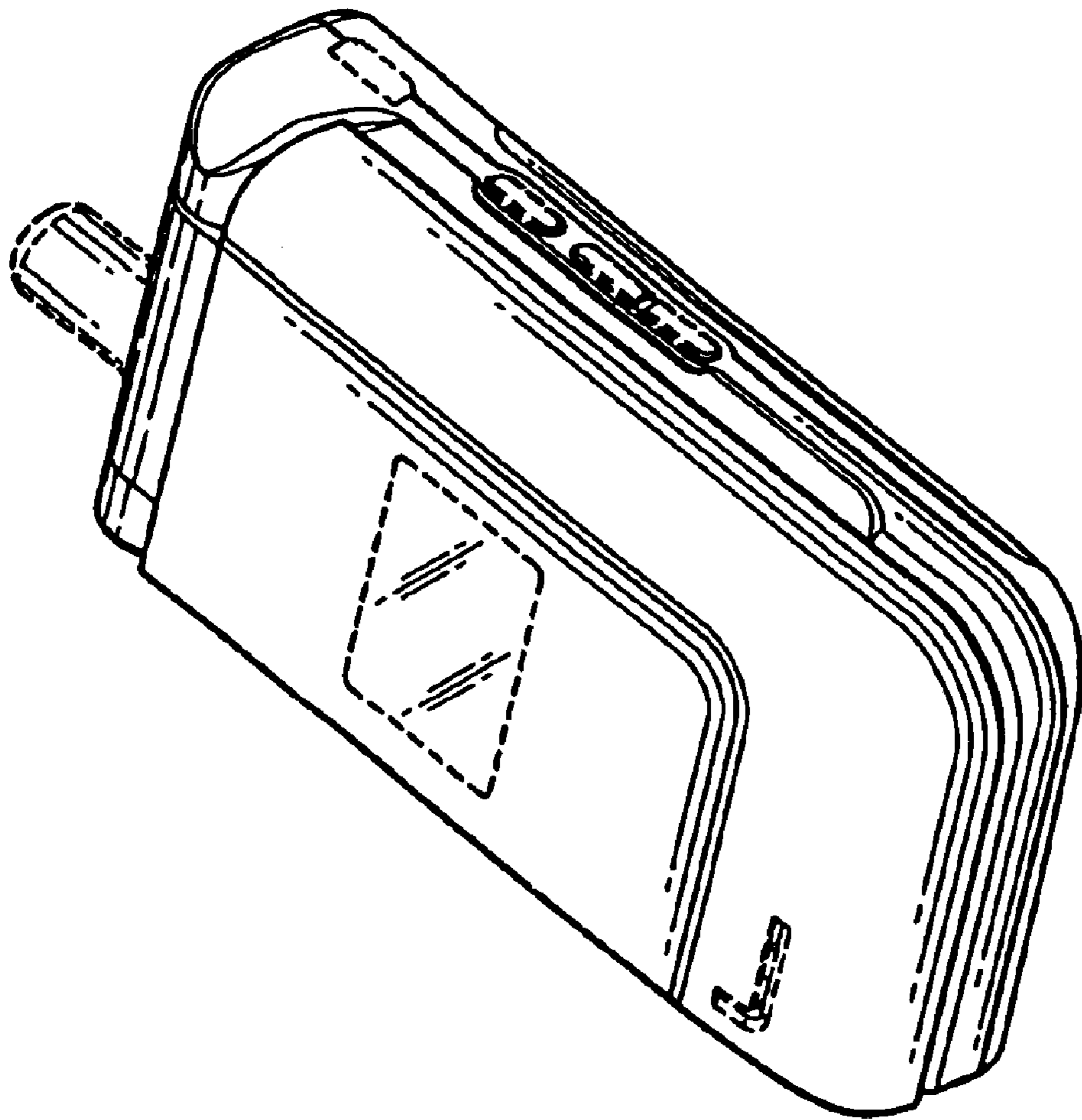


FIG. 9

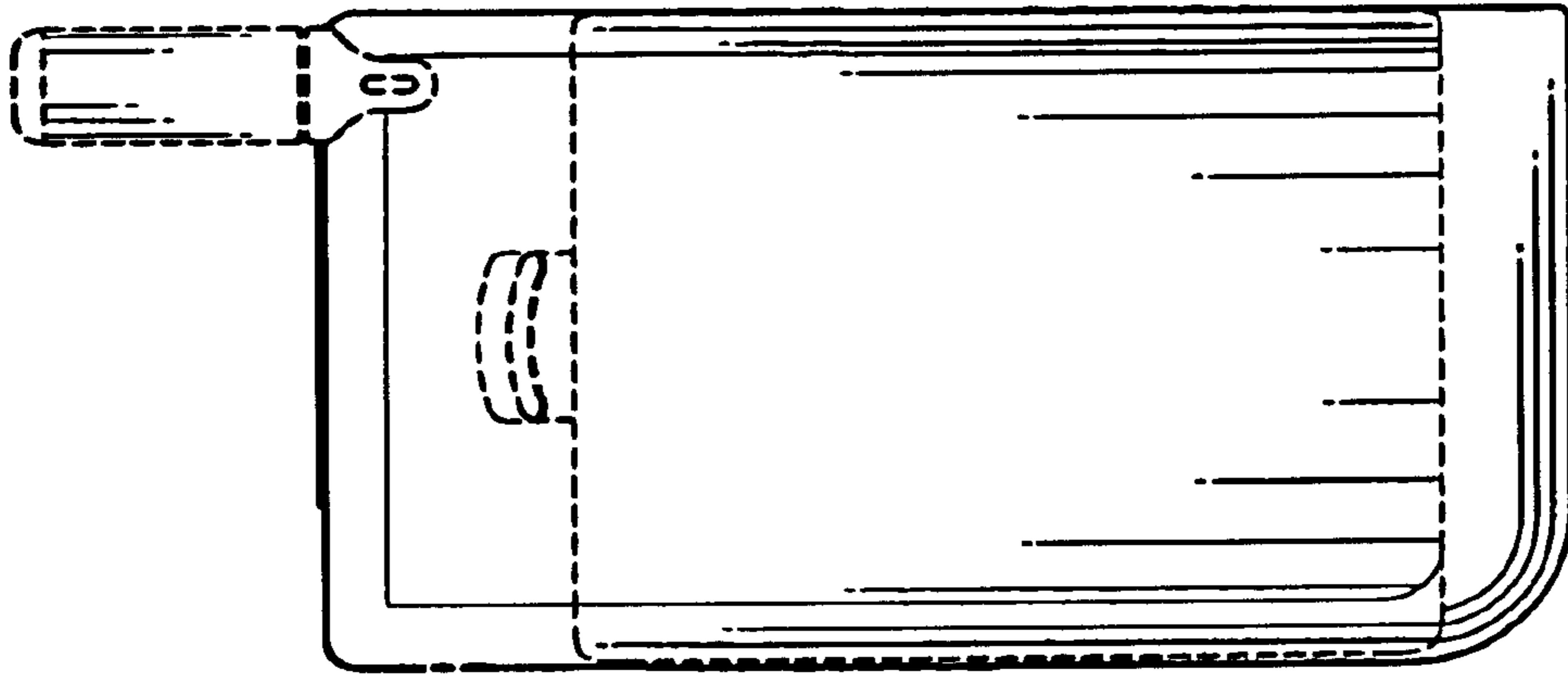


FIG. 10

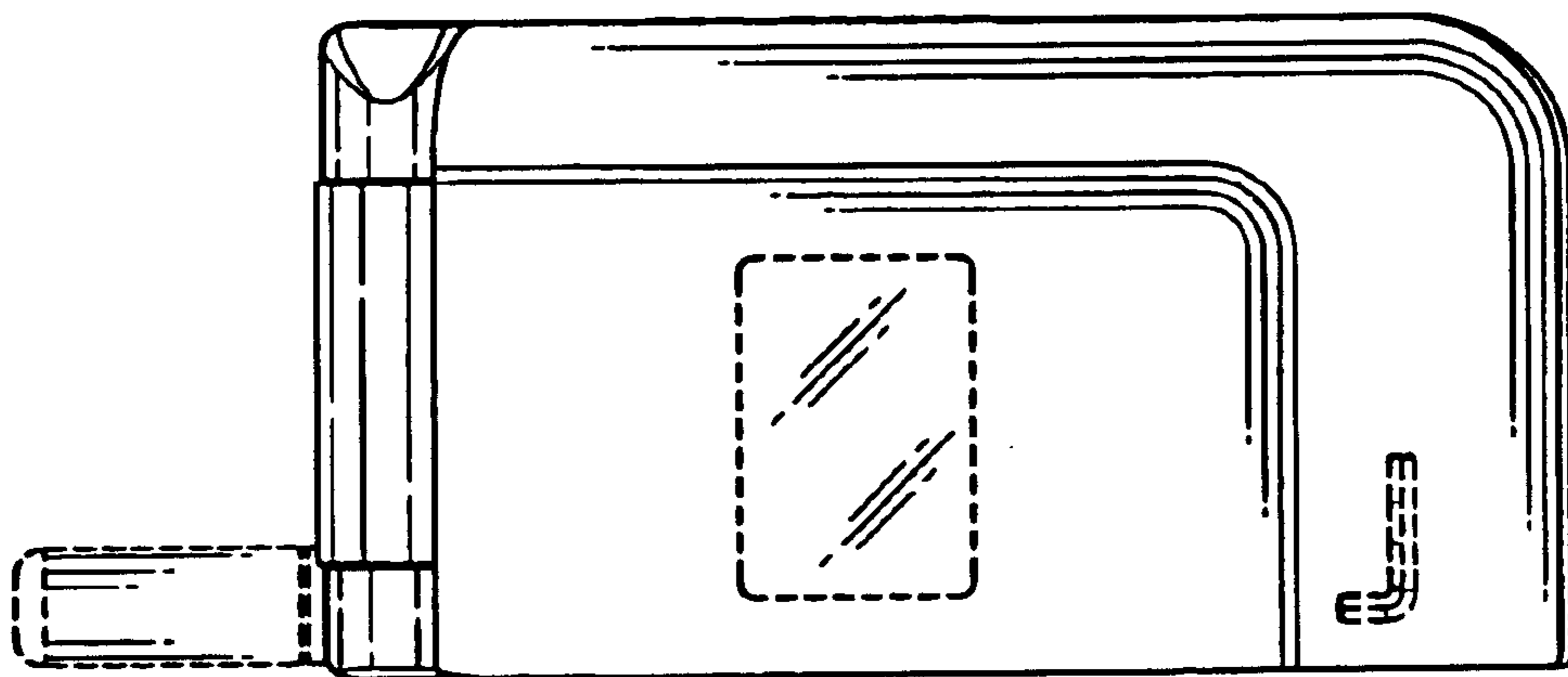


FIG. 11

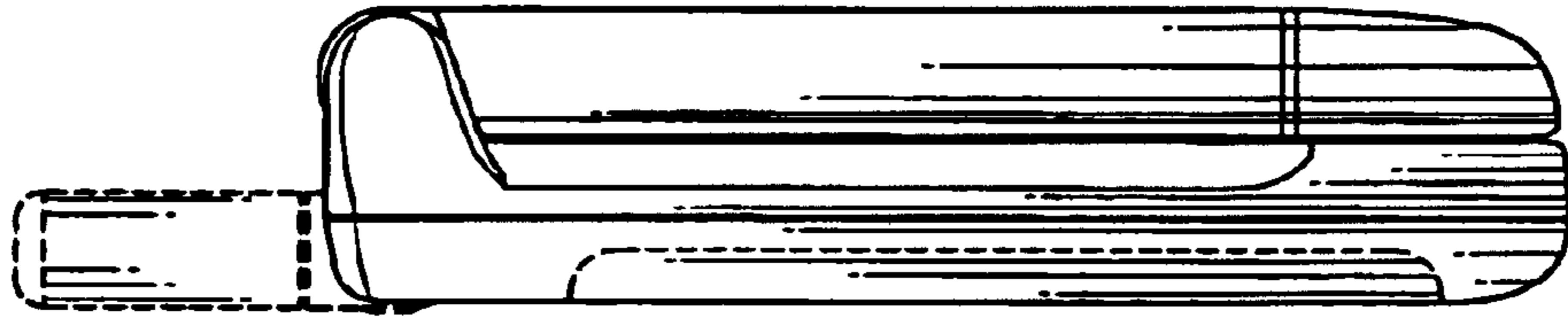


FIG. 13

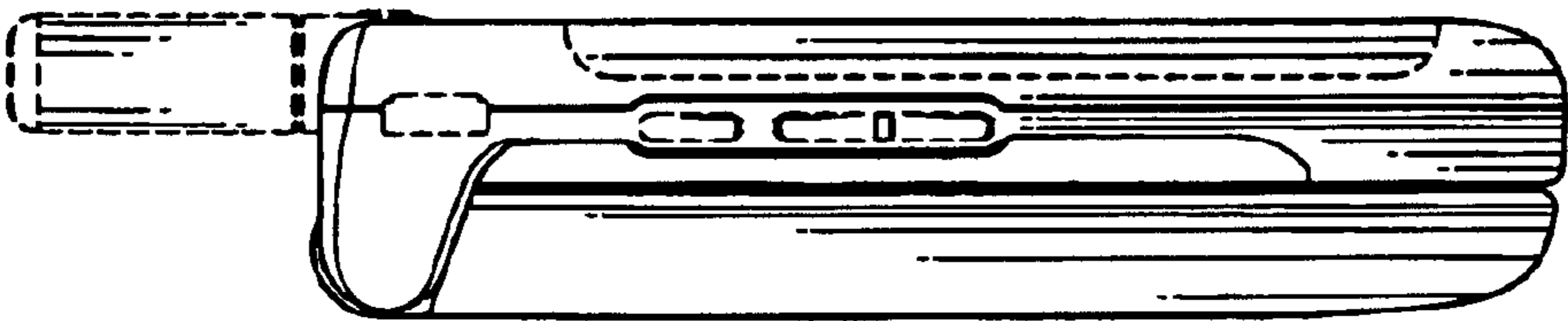


FIG. 12

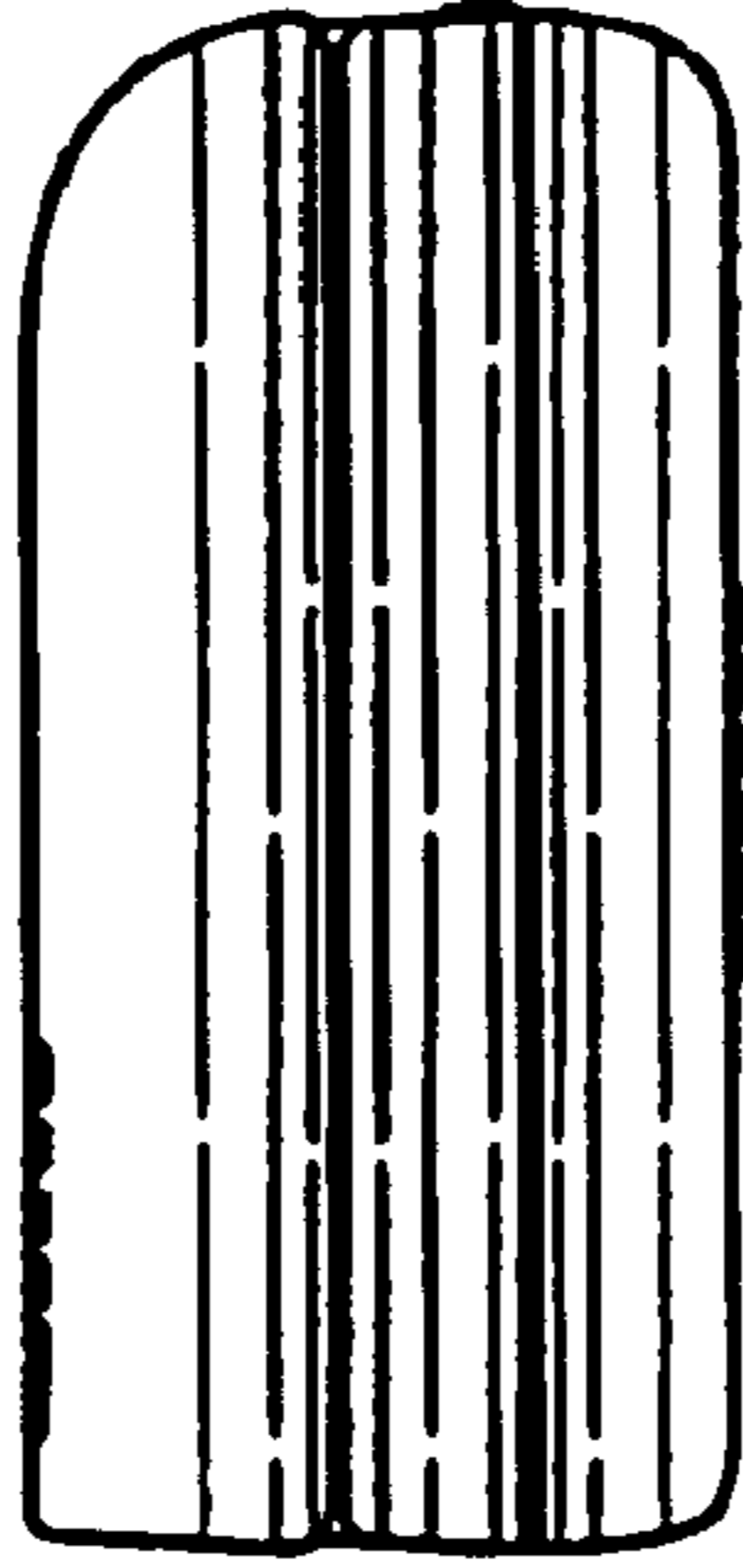


FIG. 15

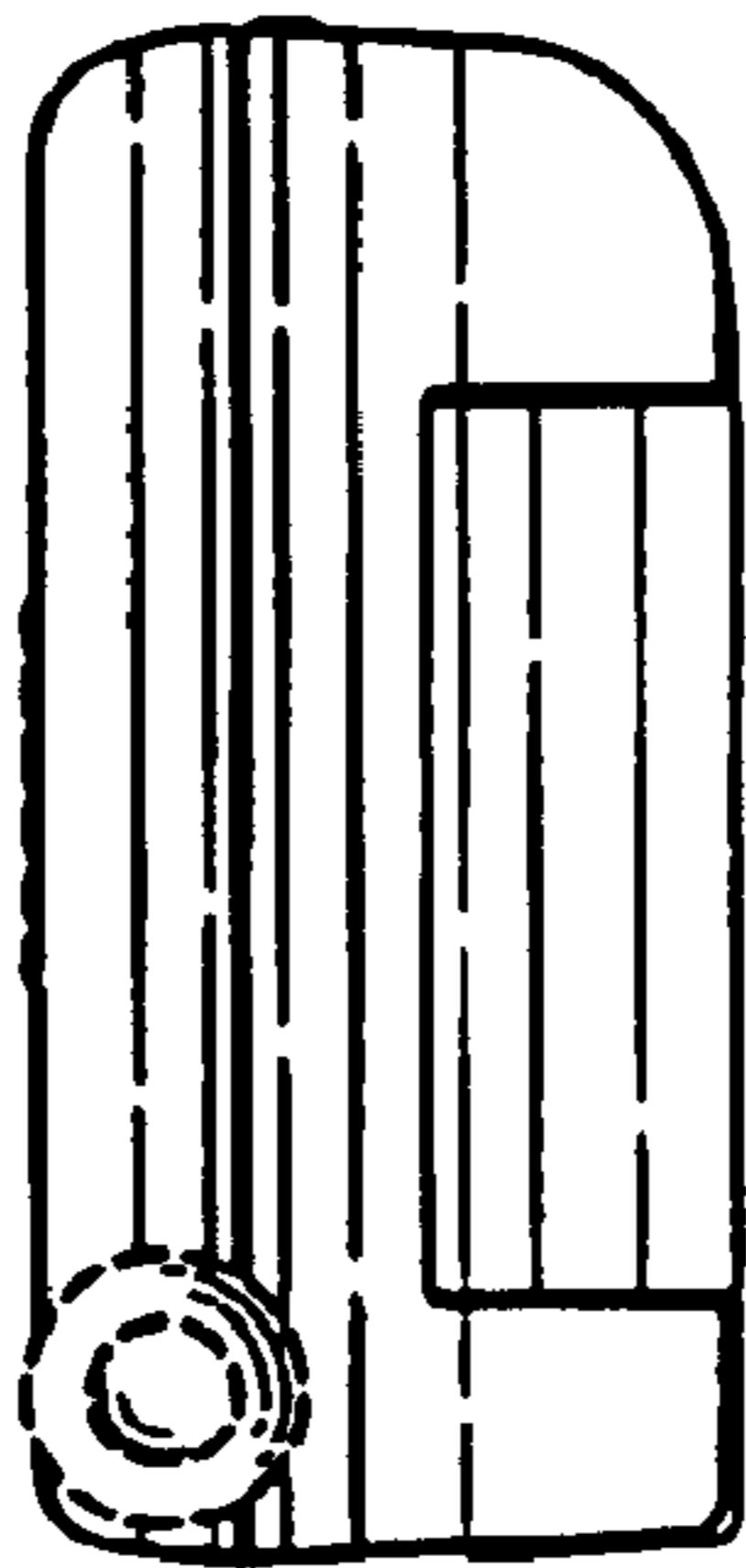


FIG. 14

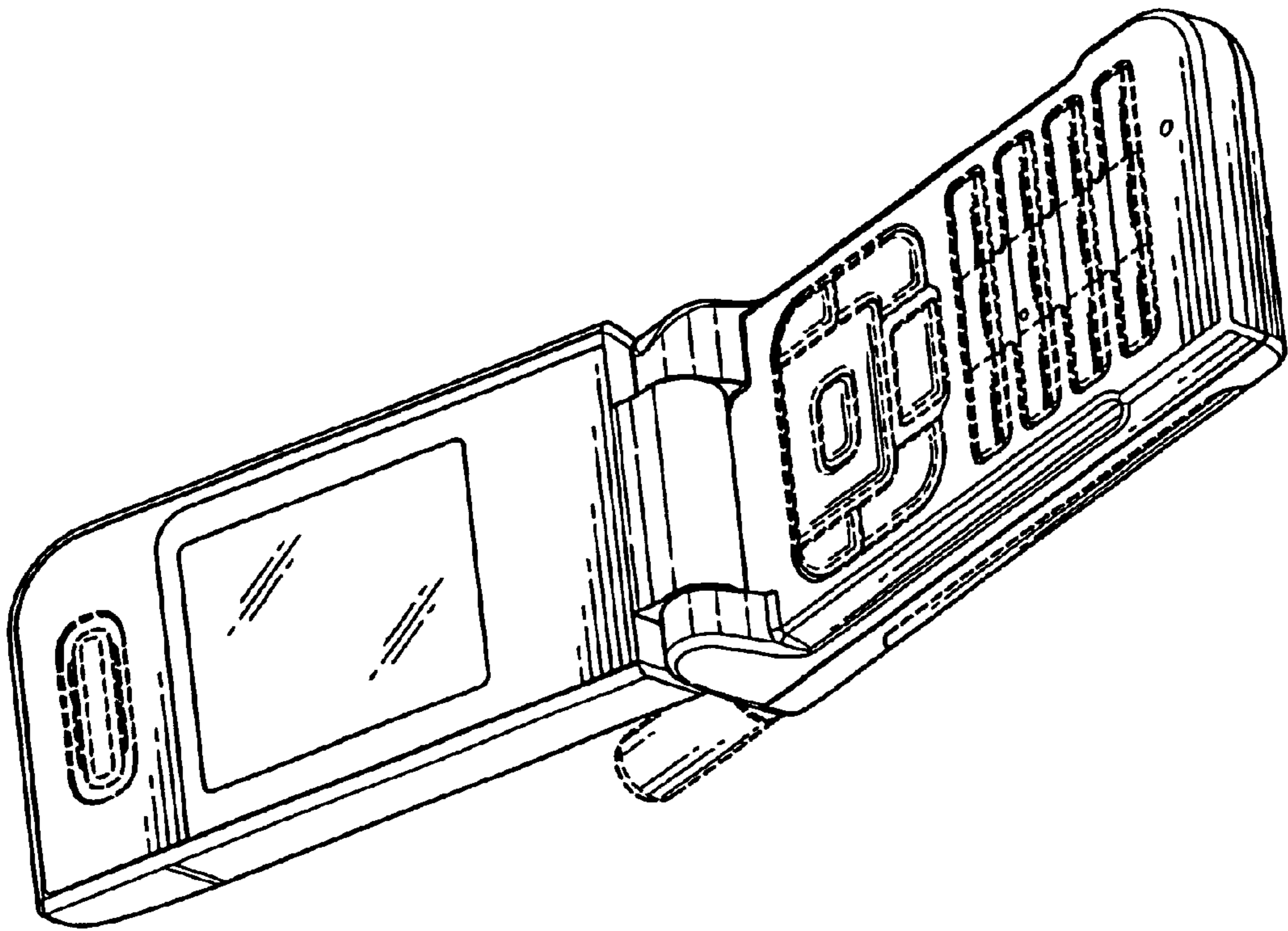


FIG. 16

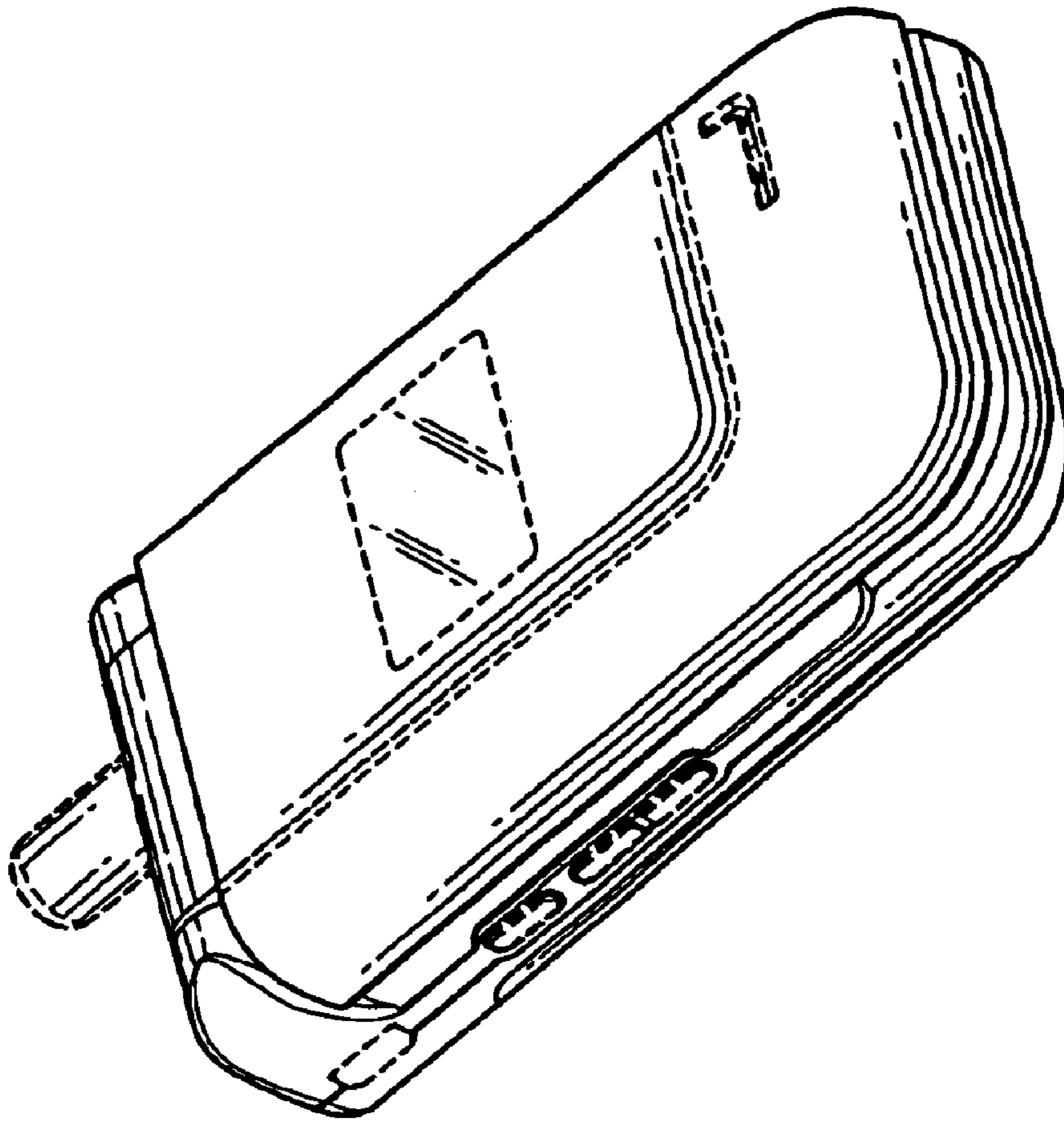


FIG. 17

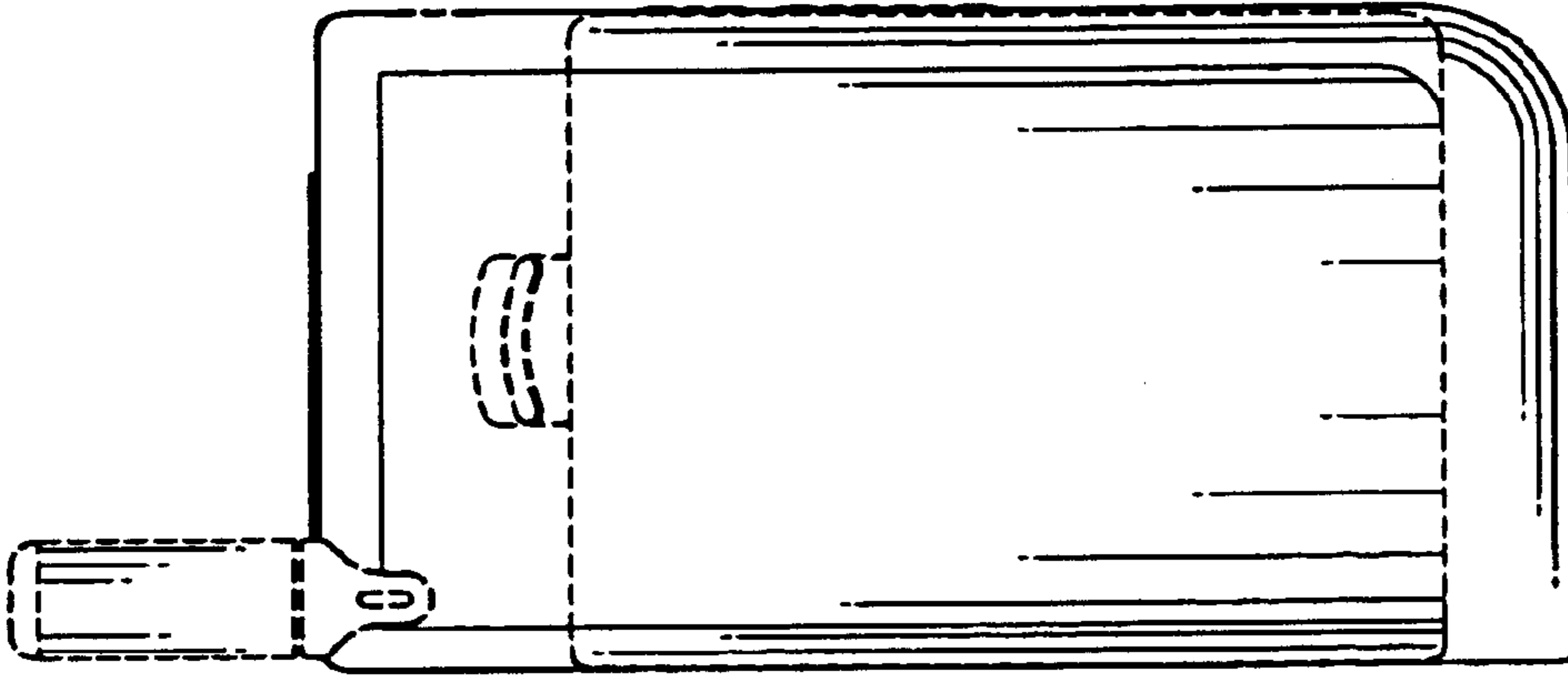


FIG. 18

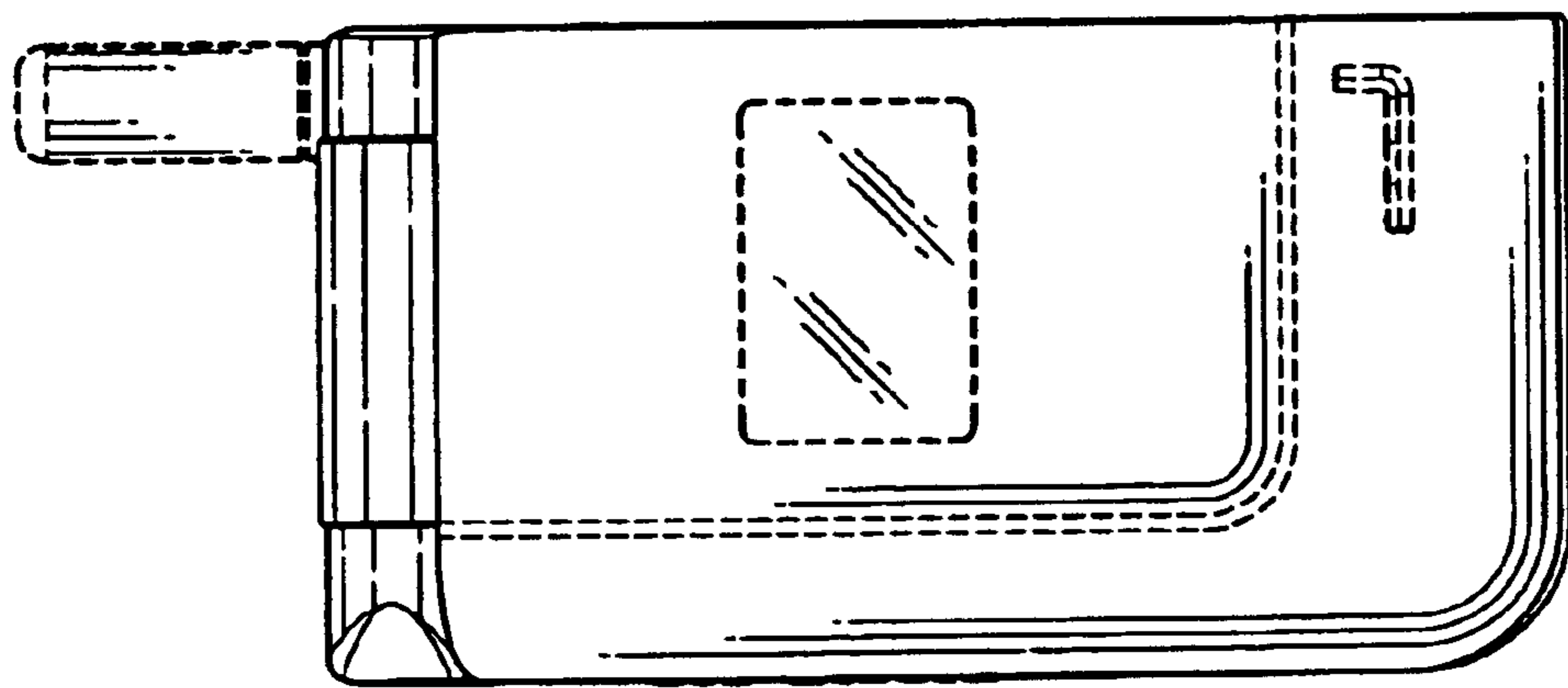


FIG. 19

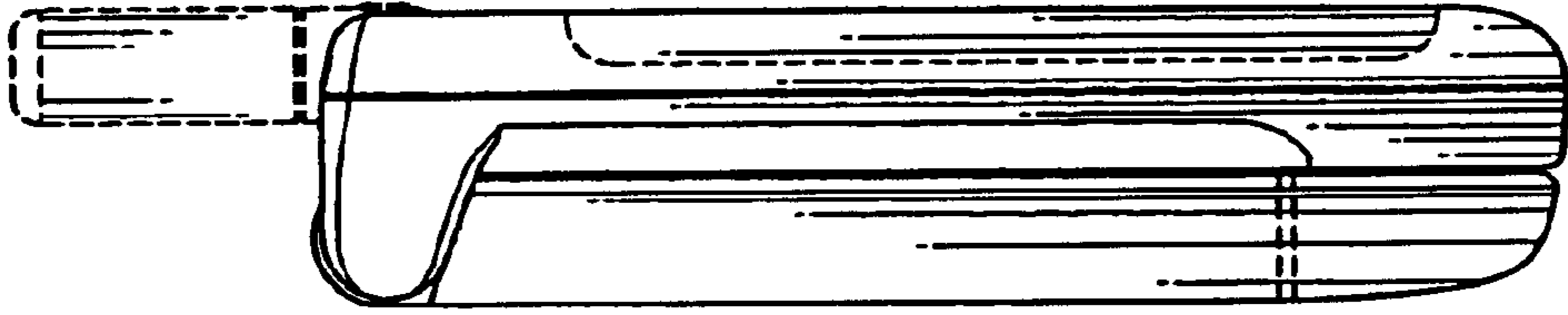


FIG. 21

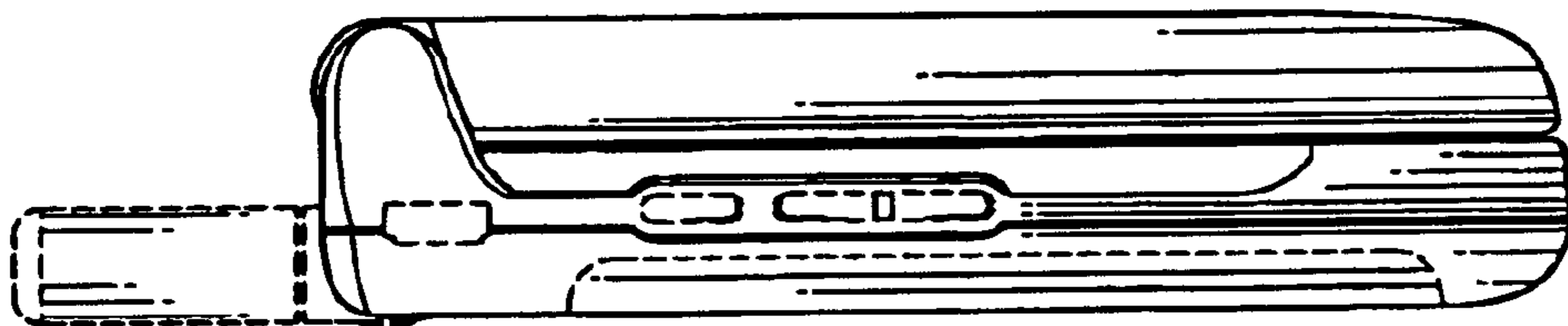


FIG. 20

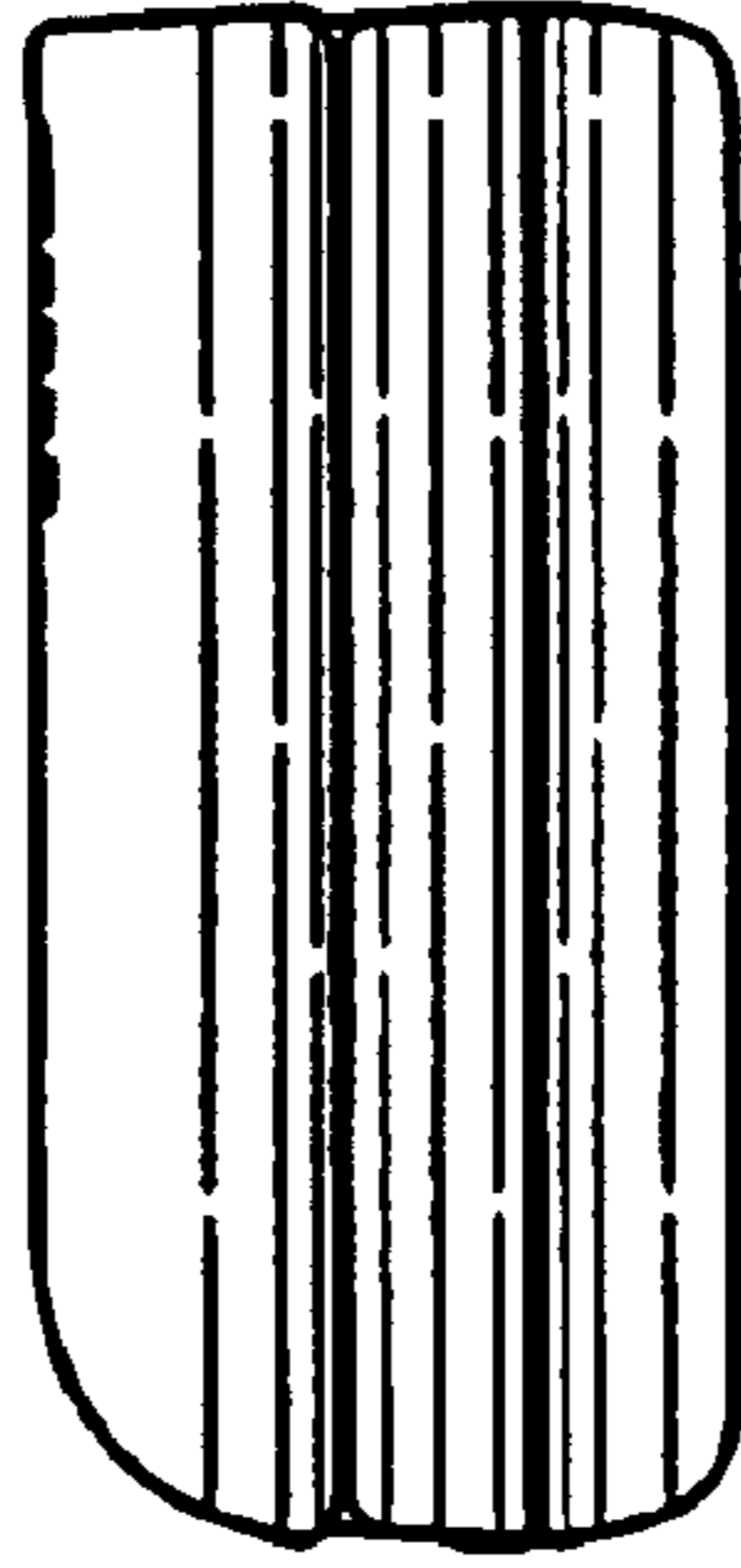


FIG. 23

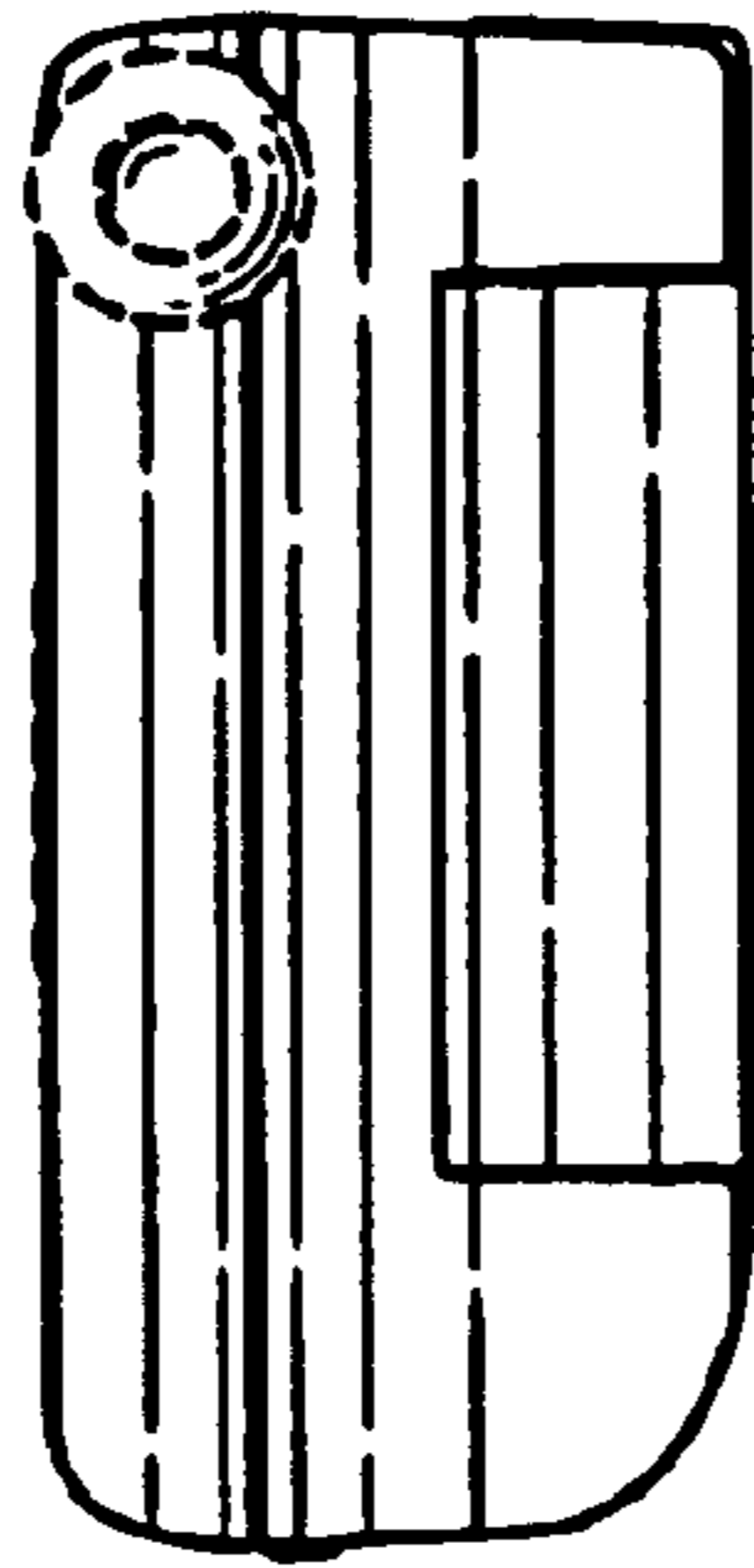


FIG. 22

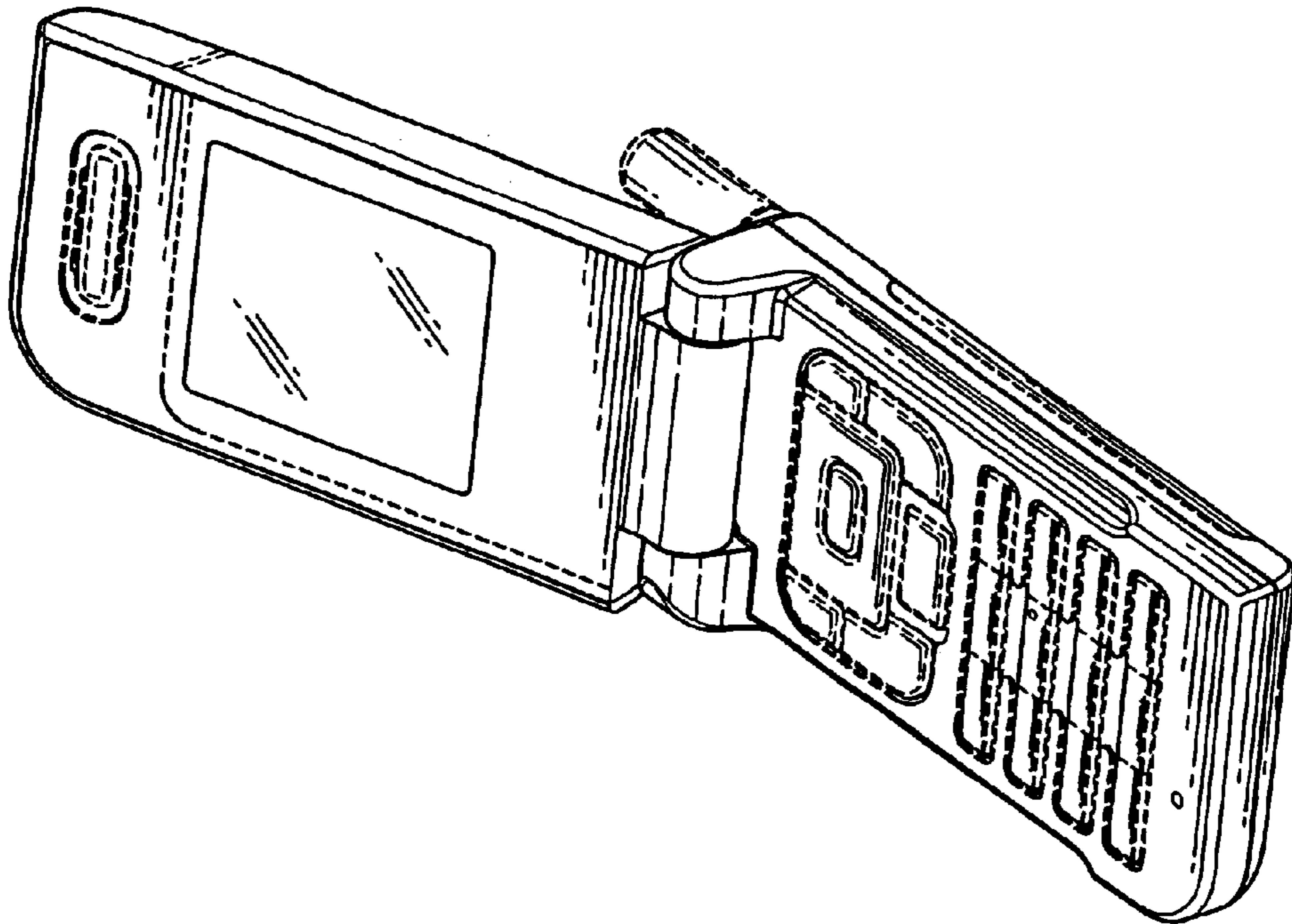


FIG. 24

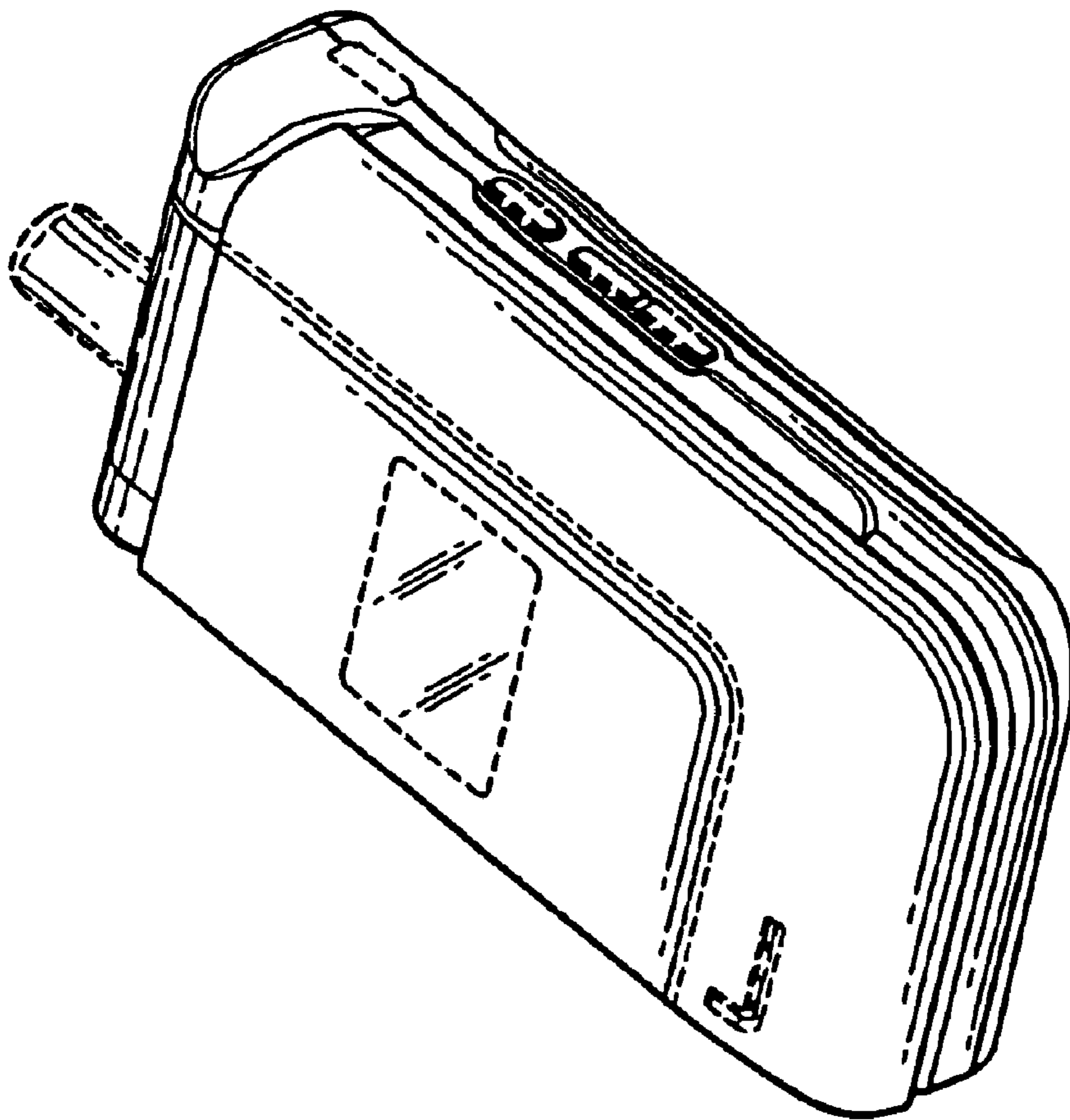


FIG. 25

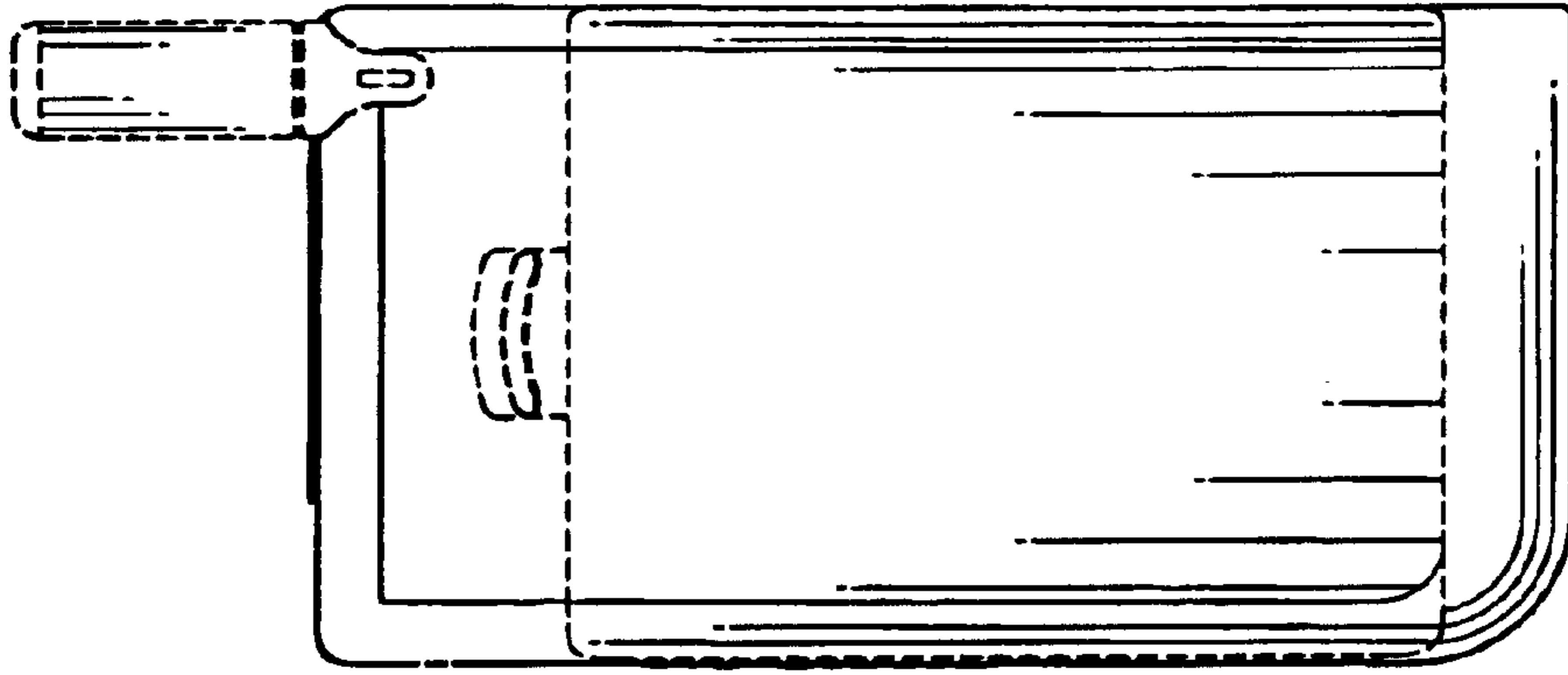


FIG. 27

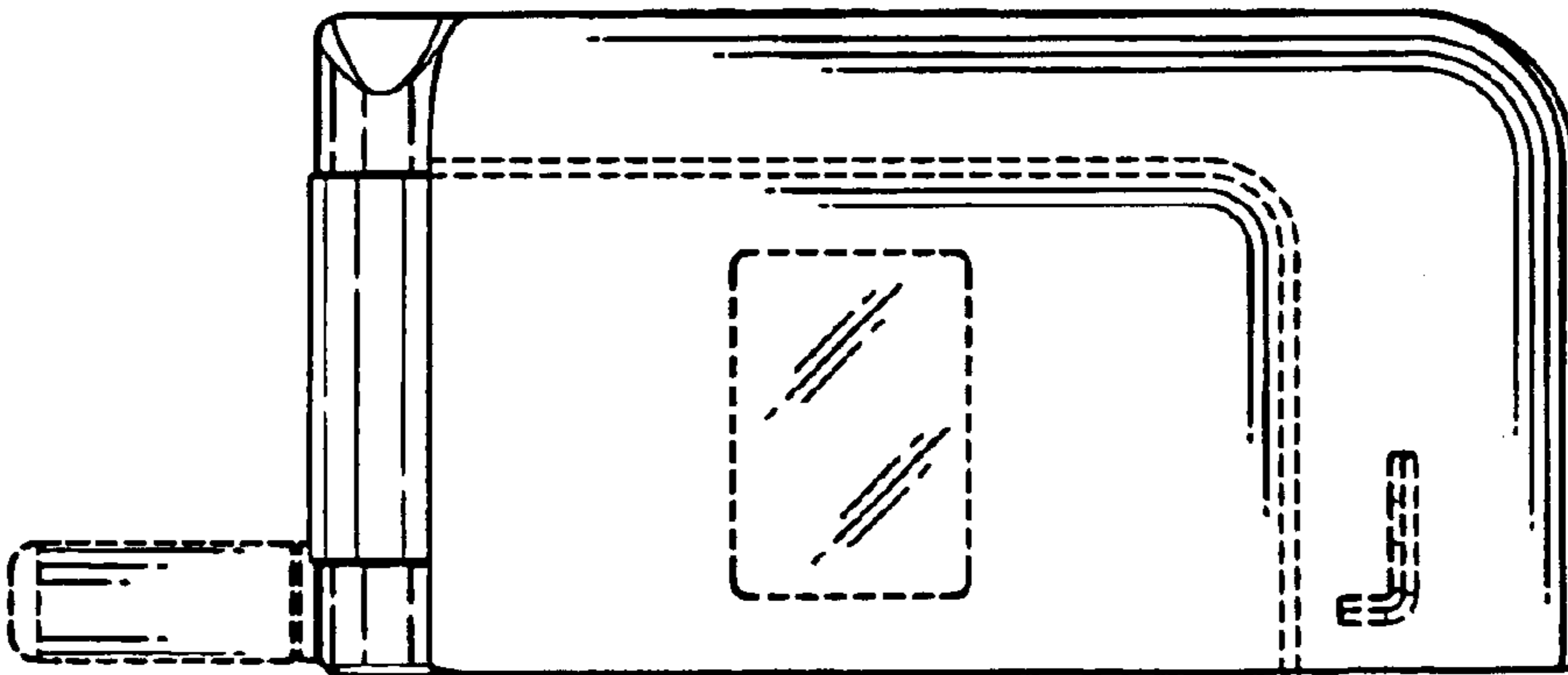


FIG. 26

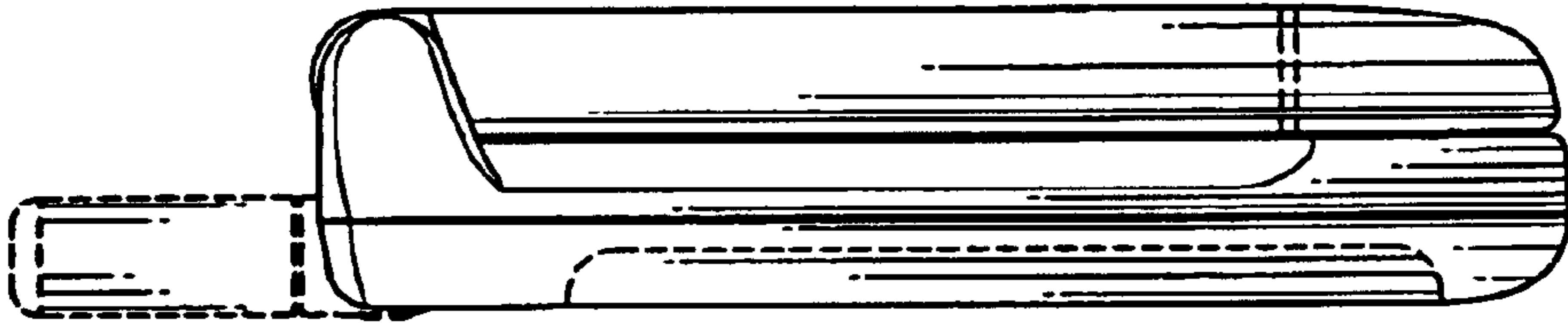


FIG. 29

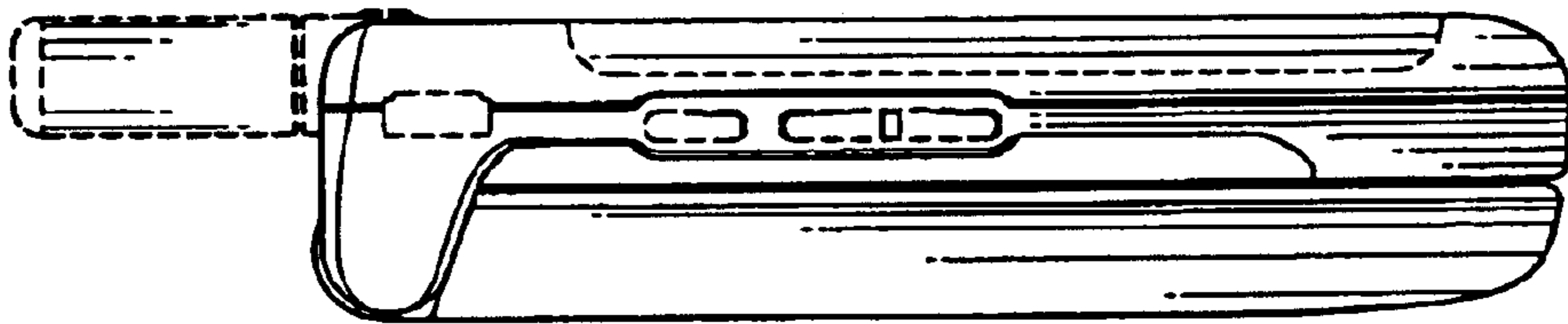


FIG. 28

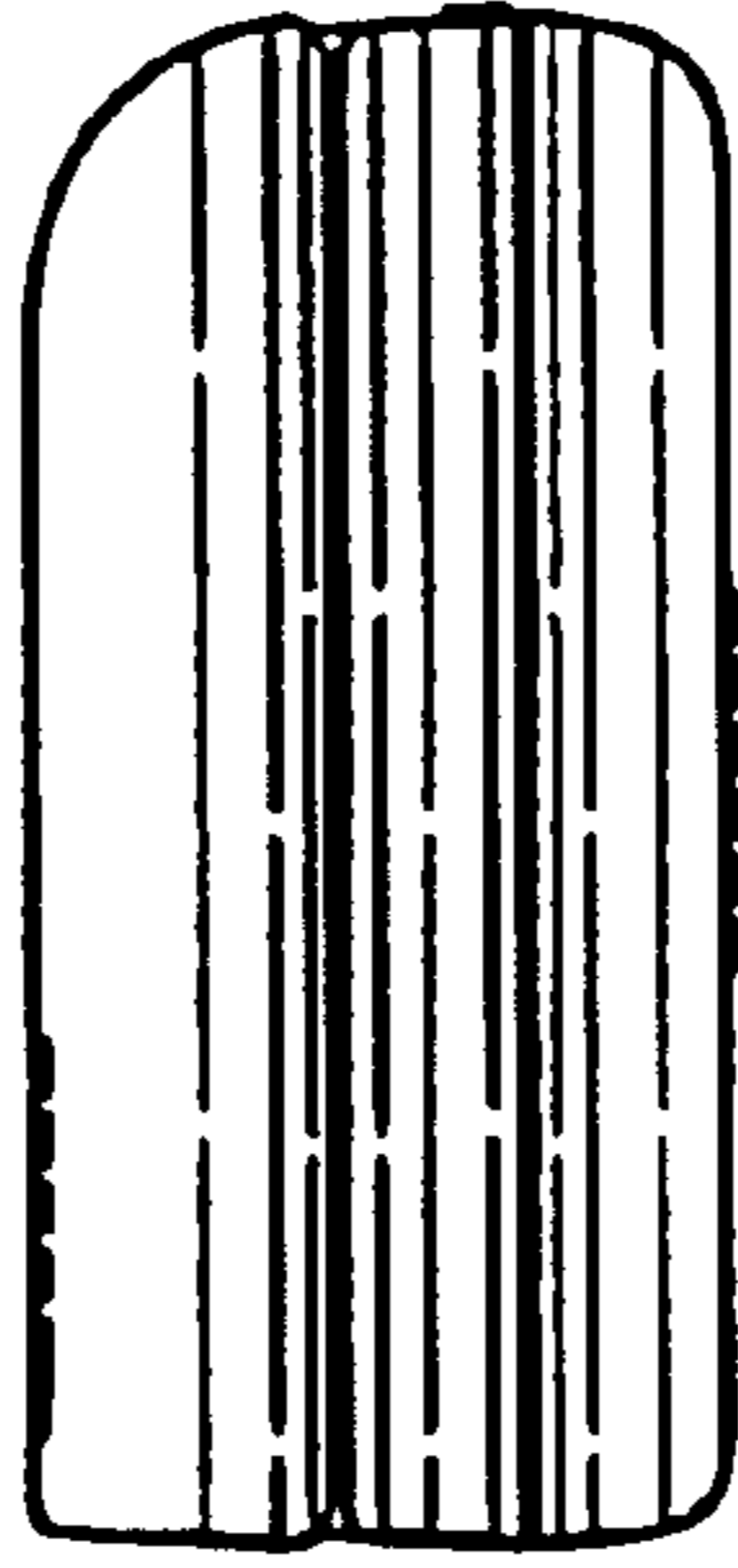


FIG. 31

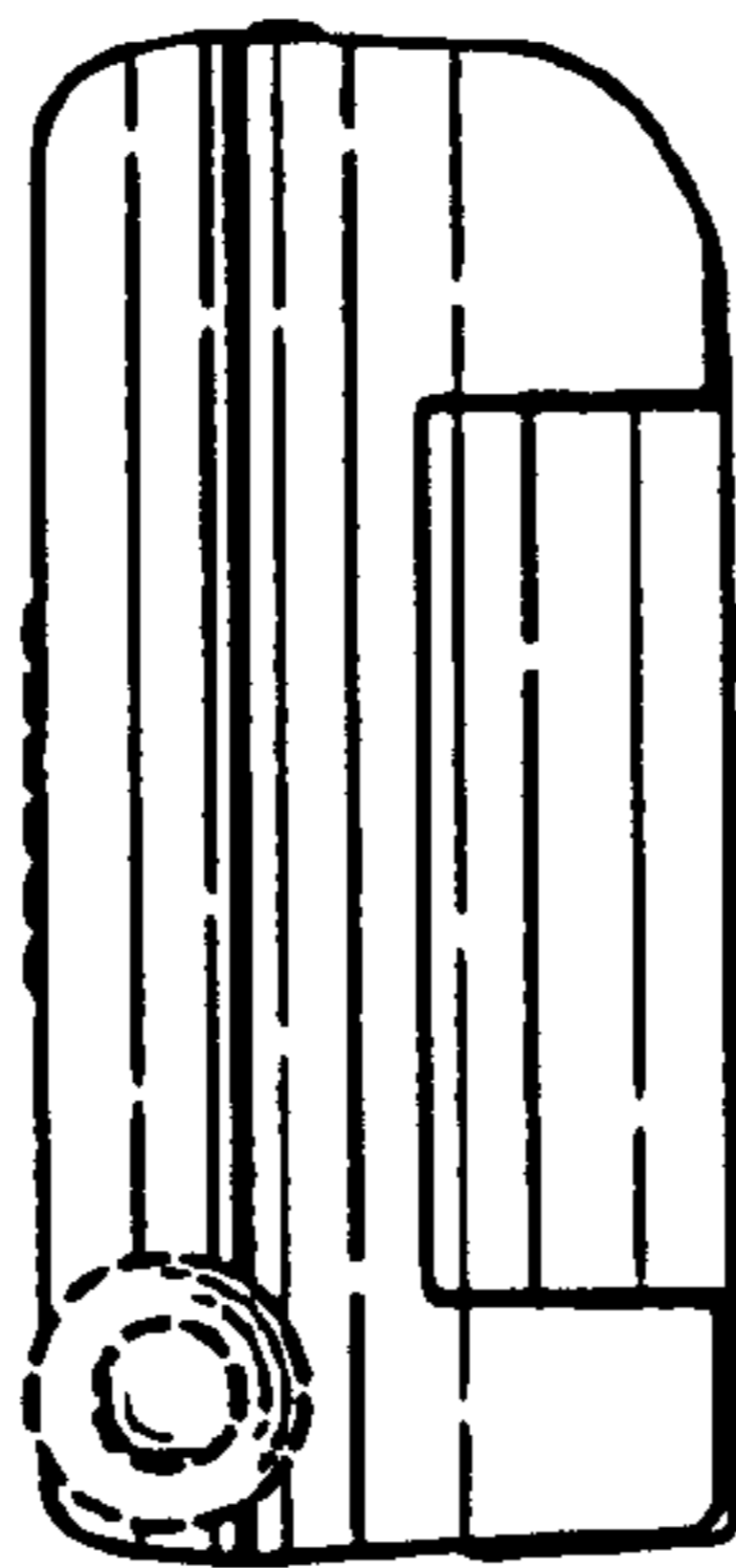


FIG. 30

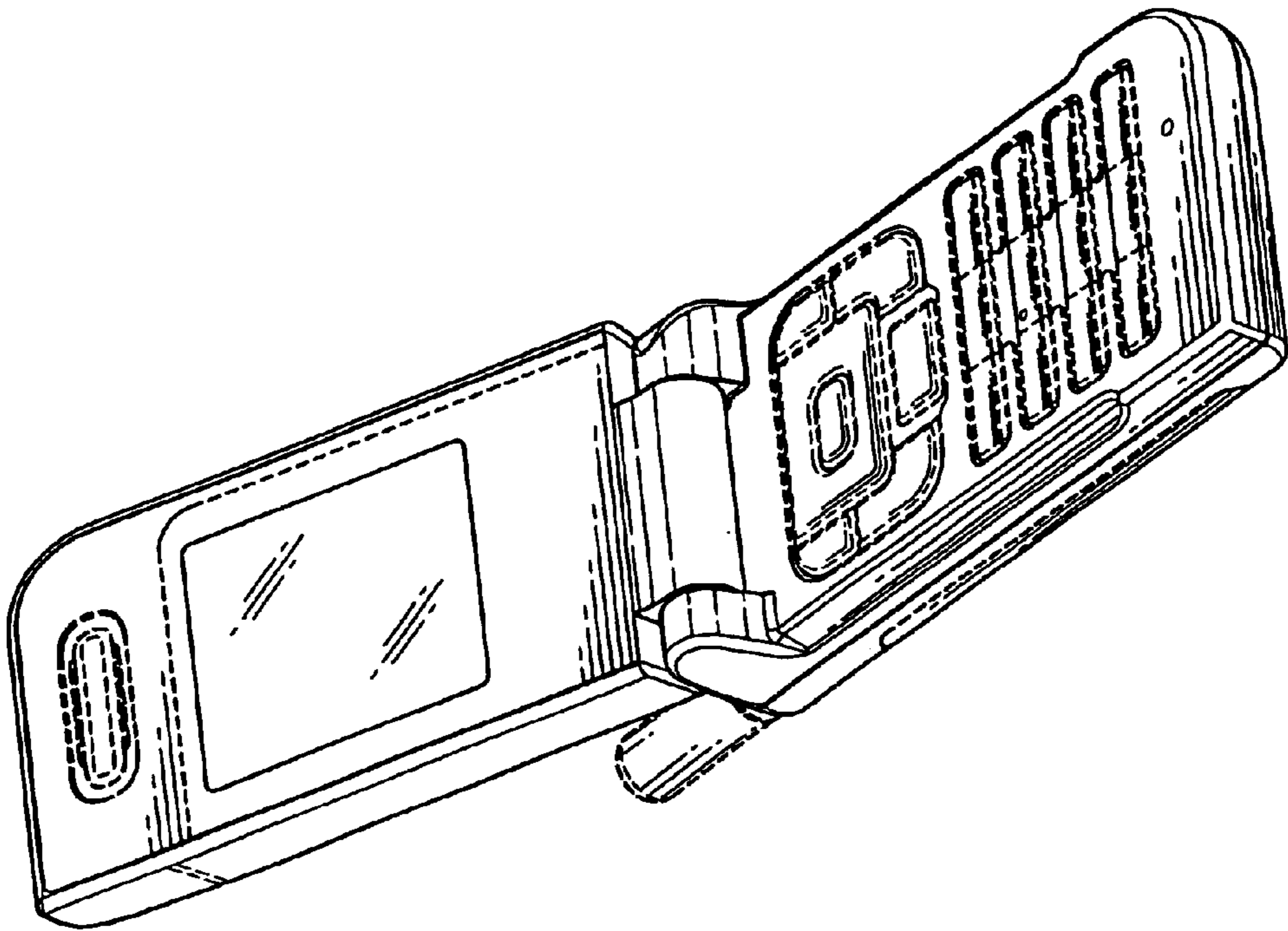


FIG. 32